

T520, Tantalum, Polymer Tantalum, 33 uF, 20%, 10 VDC, SMD, Polymer, Molded, Low Profile/ESR, NonCombustible, 70 mOhms, 3528, Height Max = 1.2mm

CATHODE (-) END VIEW For T520 Series, bevel is at KEMET's option ANODE (+) END VIEW BOTTOM VIEW Termination outout at KEMET's option, either end

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Dimensions				
Footprint	3528			
L	3.5mm +/-0.2mm			
W	2.8mm +/-0.2mm			
Н	1.1mm +/-0.1mm			
Т	0.13mm REF			
S	0.8mm +/-0.3mm			
F	2.2mm +/-0.1mm			
Α	1.9mm MIN			
X	0.05mm REF			

Packaging Specifications			
Weight	54.84 mg		
Packaging	T&R, 178mm		
Packaging Quantity	3000		

General Information				
Series	T520			
Dielectric	Polymer Tantalum			
Style	SMD Chip			
Description	SMD, Polymer, Molded, Low Profile/ESR,			
Description	NonCombustible			
Features	Low ESR			
RoHS	Yes			
Termination	Tin			
AEC-Q200	No			
Shelf Life	52 Weeks			
MSL	3			

Specifications				
Capacitance	33 uF			
Capacitance	200/			
Tolerance	20%			
Voltage DC	10 VDC (105C)			
Temperature	FF / 10F°C			
Range	-55/+105°C			
Rated	105°C			
Temperature	103 C			
Humidity	60C, 90% RH, 500 Hours, No Load			
Dissipation Factor	8% 120Hz 25C			
Failure Rate	N/A			
Resistance	70 mOhms (100kHz 25C)			
Pipple Current	1200 mA (rms, 100kHz 45C), 840 mA (rms,			
Ripple Current	85C), 300 mA (rms, 105C)			
Leakage Current	33 uA (5min 25°C)			

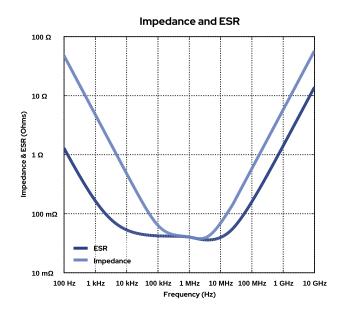
Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

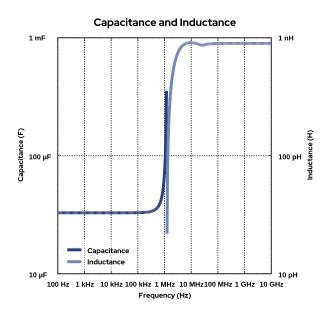


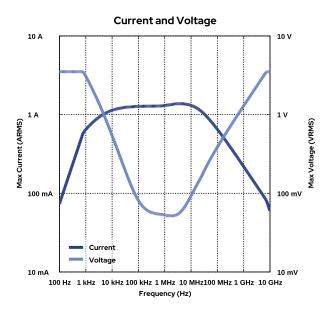
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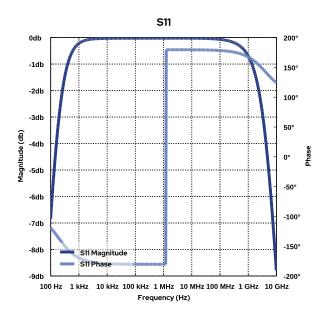
Simulations

For the complete simulation environment please visit K-SIM.



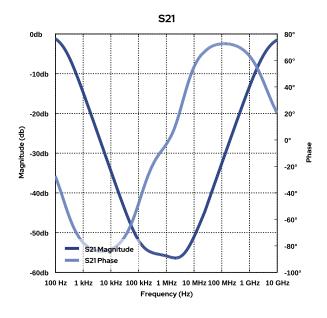








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These are simulations.

This is not a specification!

The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation affects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

The responses shown do not represent a specified or implied maximum capability of the device for all applications.

- The ESR used for ripple "Ripple Current/Voltage vs. Frequency" plots is the ESR at ambient temperature.
- The ESR in the "Temperature Rise vs. Ripple Current" plots is adjusted to each incremental temperature rise before the power and ripple current is calculated.
- · The effects shown herein are based on measured data from a multiple part sample of the parts in question.
- Ripple capability of this device will be factored by thermal resistance (Rth) created by circuit traces (addi affects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.
- The peak voltages generated in the "Temperature Rise vs. Combined Ripple Currents" plot are calculated for each frequency and are not combined with voltages generated at any other harmonics.
- · Please consult with the catalog or field applications engineer for maximum capability of the device in specific applications.

All product information and data (collectively, the "Information") are subject to change without notice.

KEMET K-SIM is designed to simulate behavior of components with respect to frequency, ambient temperature, and DC bias levels. The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation effects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

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If you have any questions please contact K-SIM.